

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Douglas Jay Mathews, et al.

Assignee: Amkor Technology, Inc.

Title: MULTI-CHIP SEMICONDUCTOR PACKAGE WITH INTEGRAL
SHIELD AND ANTENNA

Serial No.: Unknown Filed: July 16, 2003

Examiner: Unknown Group Art
Unit: Unknown

Docket No.: G006001

Monterey, CA
July 16, 2003

Mail Stop PATENT APPLICATION
Commissioner for Patents
P. O. Box 1450
Alexandria, VA 22313-1450

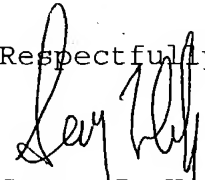
SUBMISSION OF FORMAL DRAWINGS

Dear Sir:

Applicants submit eight (8) sheets of formal drawings consisting of Figures 1, 2, 3, 4, 5, 6, 7, 8, 9, 10 and 11. If there are any questions concerning the formal drawings, please call the undersigned at the number given.

EXPRESS MAIL LABEL NO:
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Respectfully submitted,


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